

SPECIFICATION

DEVICE NAME : Power MOSFET

TYPE NAME : 2SK2528-01

SPEC. No. : - - - - -

Fuji Electric Co.,Ltd.

This Specification is subject to change without notice.

	DATE	NAME	APPROVED	Fuji Electric Co.,Ltd.
DRAWN				DWG.NO. 1/11
CHECKED				

1. Scope
This specifies Fuji power MOSFET 2SK2528-01
2. Construction N-channel enhancement mode power MOSFET
3. Application for switching
4. Outview TO-3P Outviwe See to 5/11 page
5. Absolute maximum ratings at Tc=25°C (unless otherwise specified)

Description	Symbol	Characteristics	Unit	Remarks
Drain-source voltage	V_{DS}	900	V	
Drain-gate voltage	V_{DGR}	900	V	$R_{GS} = 2.0 K\Omega$
Continuous Drain current	I_D	± 5	A	
Pulsed drain current	I_{Dpulso}	± 20	A	
Gate-source voltage	V_{GS}	± 30	V	
Maximum power dissipation	P_D	80	W	
Operating and storage temperature range	T_{ch}	150	°C	
	T_{sto}	-55 ~ +150	°C	

6. Electrical characteristics at Tc=25°C (unless otherwise specified)
Static ratings

Description	Symbol	Conditions	Characteristics			Unit	
			Min.	Typ.	Max.		
Drain-source breakdown voltage	BV_{DSS}	$I_D = 1mA$ $V_{GS} = 0V$	900			V	
Gate threshold voltage	$V_{GS(th)}$	$I_D = 1mA$ $V_{DS} = V_{GS}$	2.5	3.0	3.5	V	
Zero gate voltage drain current	I_{DSS}	$V_{DS} = 900V$ $V_{GS} = 0V$	$T_{ch} = 25^\circ C$		10	500	μA
	I_{DSS}		$T_{ch} = 125^\circ C$		0.2	1.0	mA
Gate-source leakage current	I_{GSS}	$V_{GS} = \pm 30V$ $V_{DS} = 0V$		10	100	nA	
Drain-source on-state resistance	$R_{DS(on)}$	$I_D = 2.5A$ $V_{GS} = 10V$		2.7	3.6	Ω	

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Dynamic ratings

Description	Symbol	Conditions	Characteristics			Unit
			Min.	Typ.	Max.	
Forward transconductance	g f s	$I_D = 2.5A$ $V_{DS} = 25V$	2.0	4.0		S
Input capacitance	Ciss	$V_{DS} = 25V$ $V_{GS} = 0V$ $f = 1MHz$		750	1150	pF
Output capacitance	Coss			95	145	pF
Reverse transfer capacitance	Crss			40	60	pF
Turn-on time	t d(on)	$V_{CC} = 600V$ $V_{GS} = 10V$ $I_D = 5A$ $R_{GS} = 10\Omega$		20	30	ns
	t r			35	55	ns
Turn-off time	t d(off)			70	110	ns
	t f			35	55	ns

Reverse diode

Description	Symbol	Conditions	Characteristics			Unit
			Min.	Typ.	Max.	
Avalanche capability	I_{AV}	$L = 100\mu H$, $T_{ch} = 25^\circ C$ * see Fig1 and Fig2	5.0			A
Diode forward on-voltage	V_{SD}	$I_F = 2 \times I_{DR}$ $V_{GS} = 0V$, $T_{ch} = 25^\circ C$		0.95	1.45	V
Reverse recovery time	t_{rr}	$I_F = I_{DR}$ $V_{GS} = 0V$ $-di_F/dt = 100A/\mu s$ $T_{ch} = 25^\circ C$		1100		ns
Reverse recovery charge	Q_{rr}				5.5	

7. Thermal resistance

Description	Symbol	Conditions	Characteristics			Unit
			Min.	Typ.	Max.	
Thermal resistance	$R_{th_{ch-c}}$				1.56	$^\circ C/W$
	$R_{th_{ch-a}}$				62.5	$^\circ C/W$

Fig.1 Test circuit

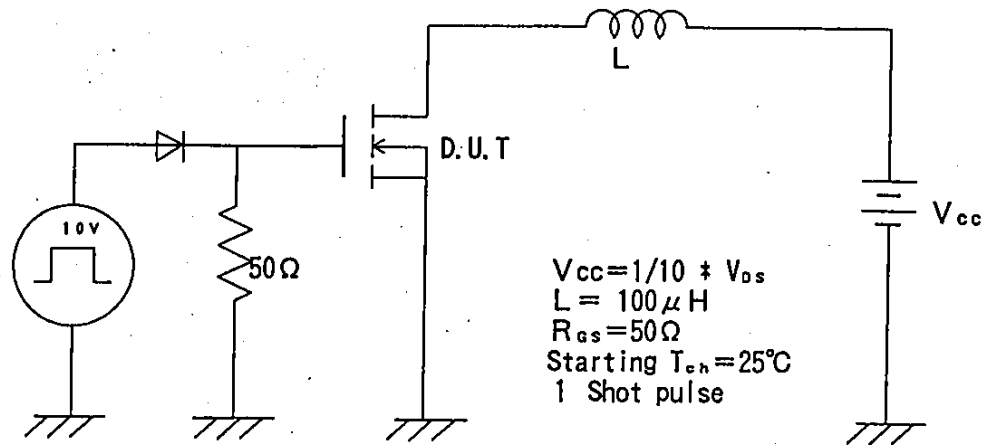
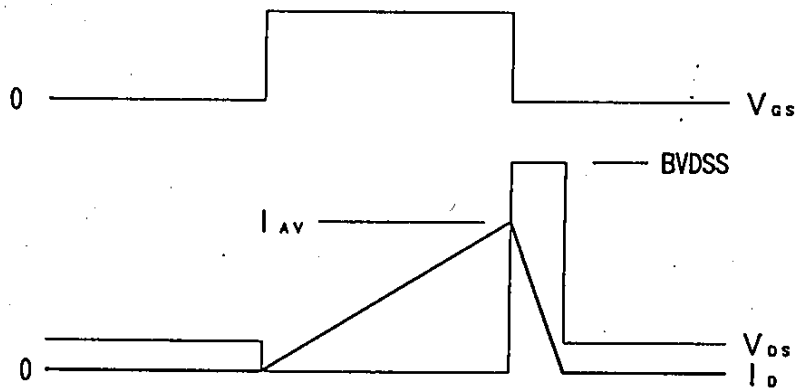
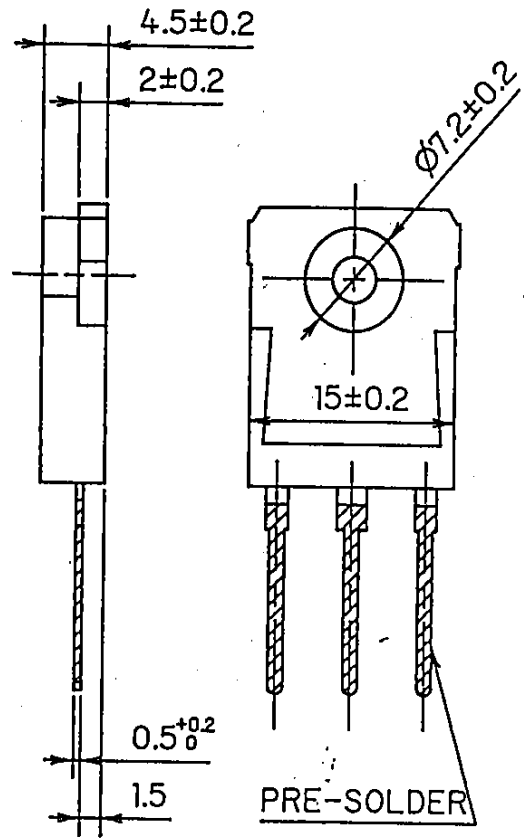
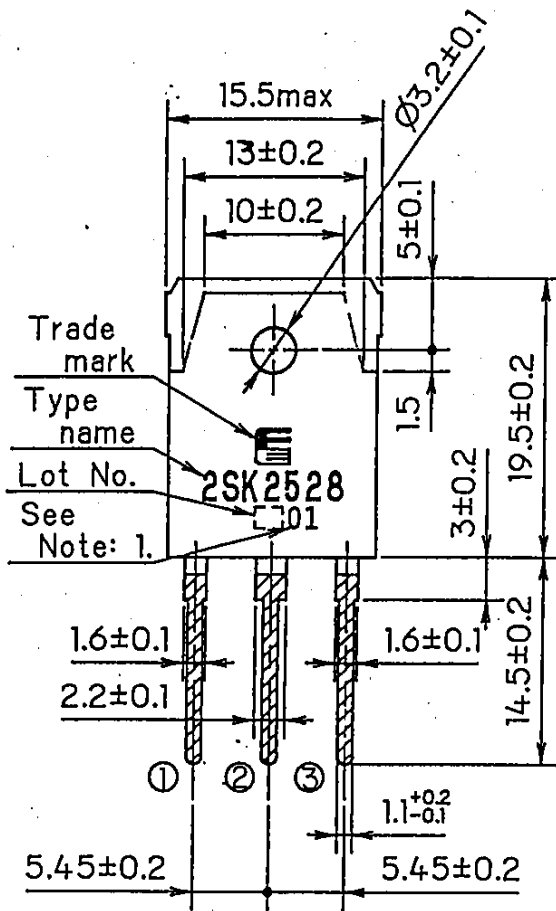


Fig.2 Operating waveforms

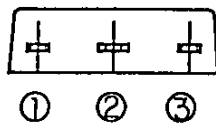


FUJI POWER MOS FET

TYPE : 2SK2528-01



DIMENSIONS ARE IN MILLIMETERS.



CONNECTION

- ① GATE
- ② DRAIN
- ③ SOURCE

Note: 1. Guaranteed mark of avalanche ruggedness.

JEDEC : TO-247
EIAJ : SC-65

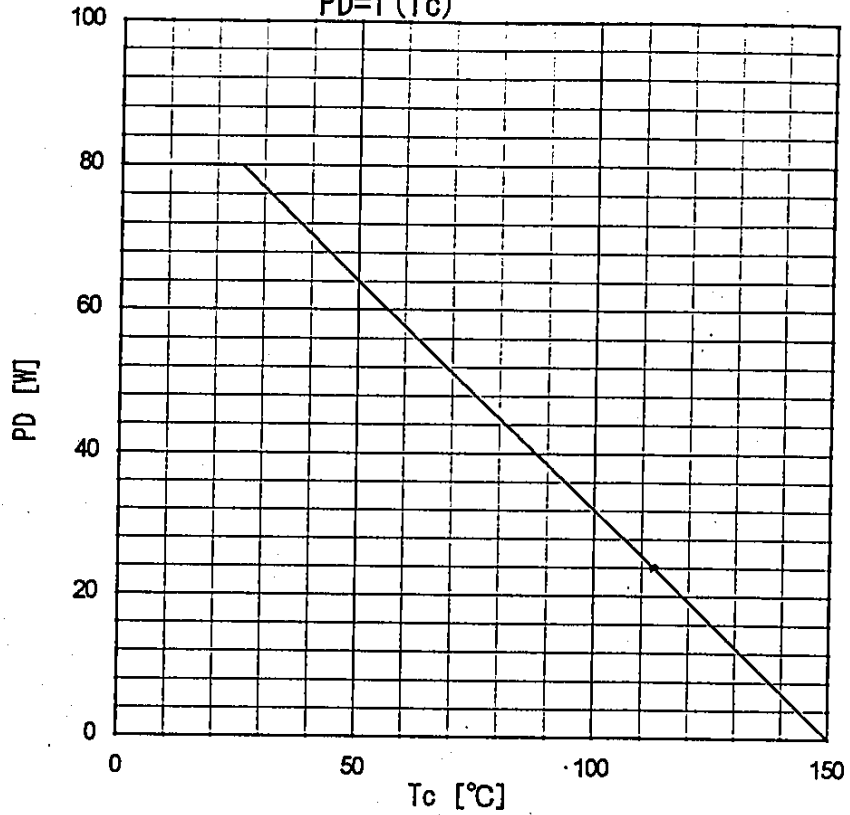
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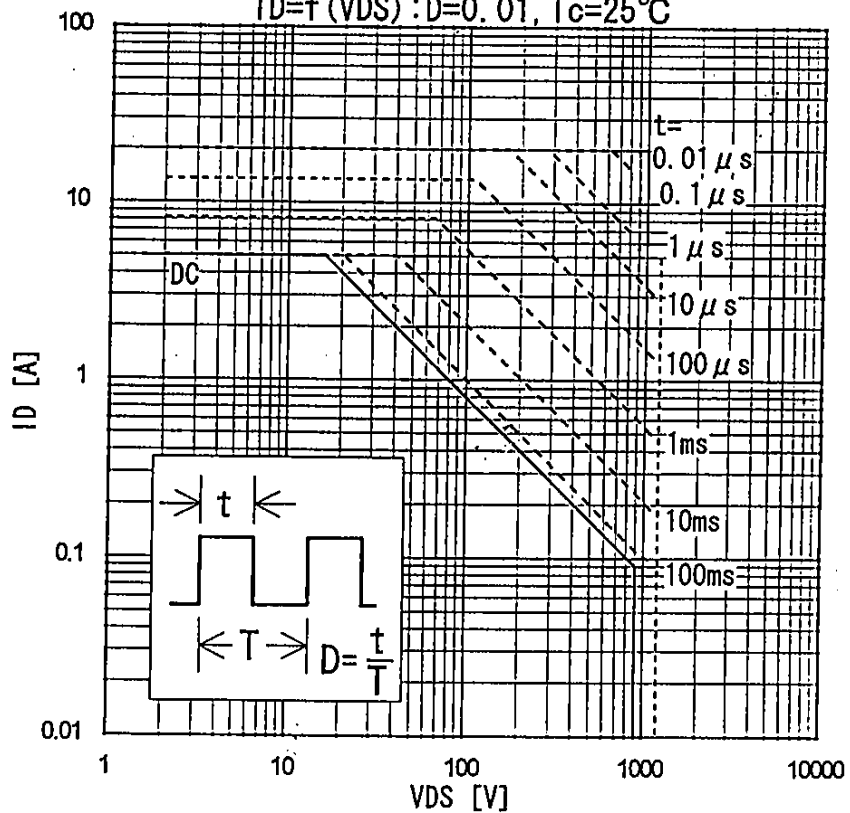
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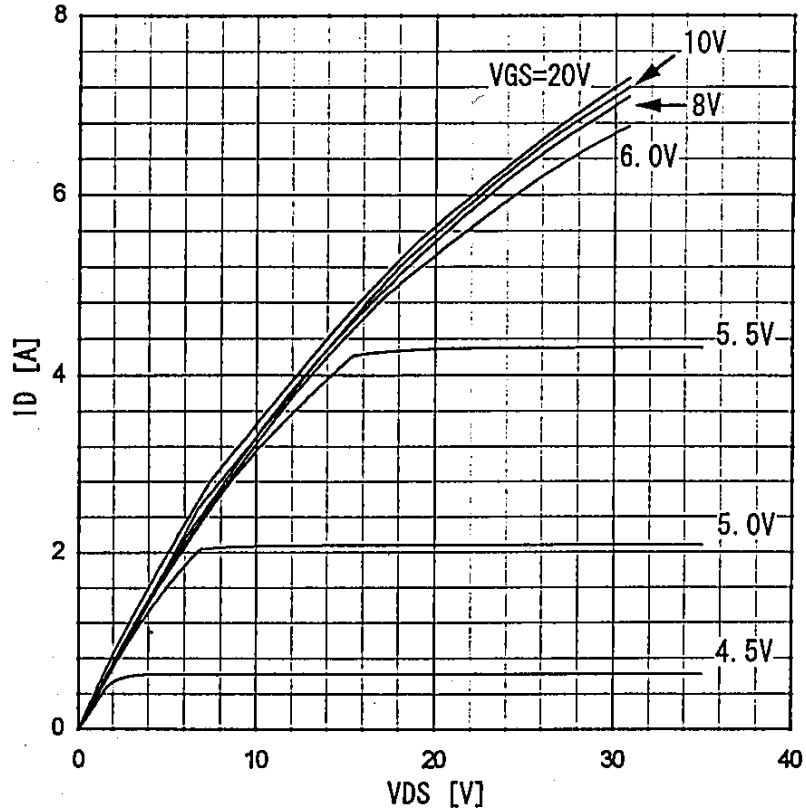
Power Dissipation
 $PD=f(T_c)$



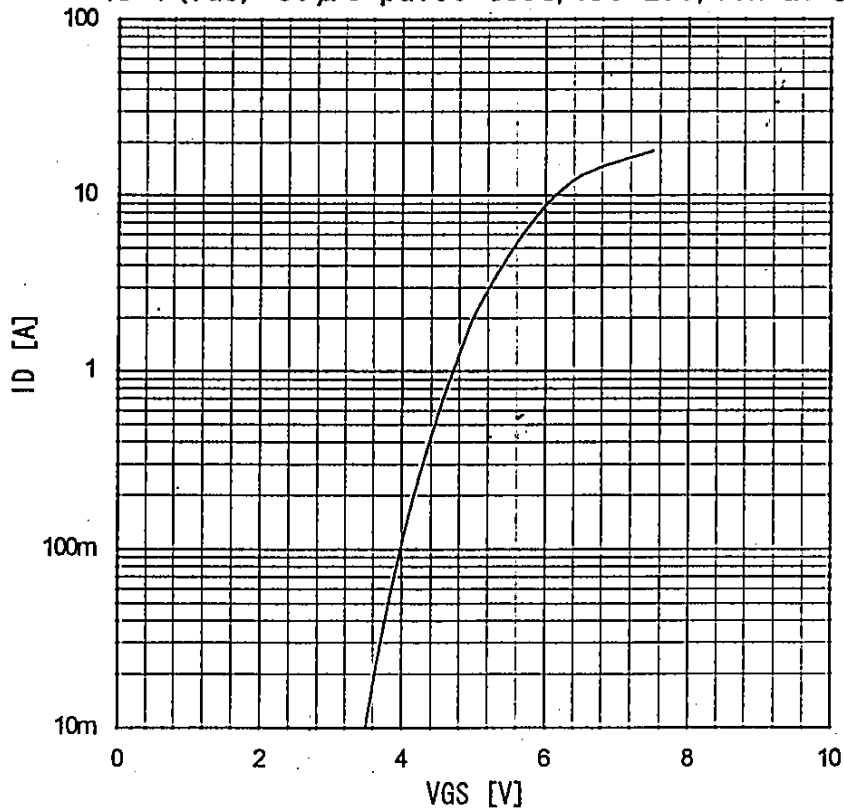
Safe operating area
 $ID=f(V_{DS}) : D=0.01, T_c=25^\circ\text{C}$



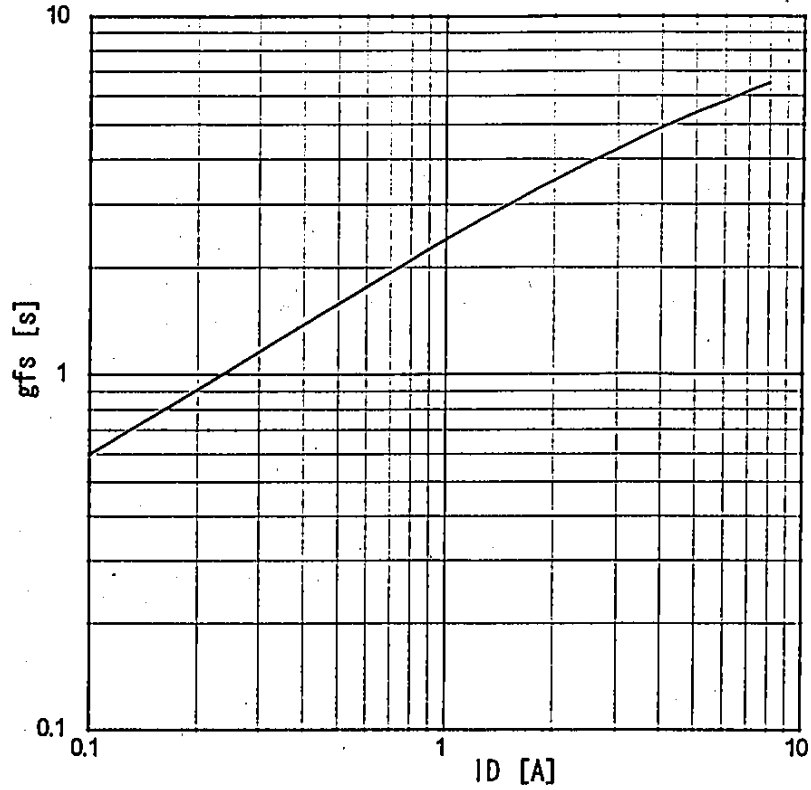
Typical output characteristics
 $I_D = f(V_{DS})$: 80 μ s pulse test, $T_{ch} = 25^\circ\text{C}$



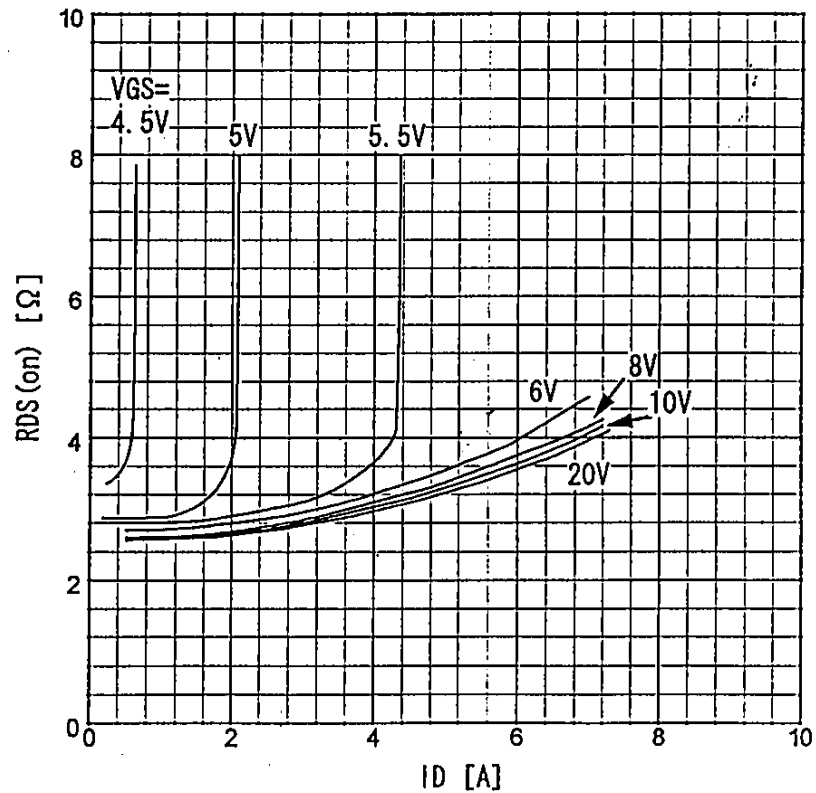
Typical transfer characteristic
 $I_D = f(V_{GS})$: 80 μ s pulse test, $V_{DS} = 25V$, $T_{ch} = 25^\circ\text{C}$



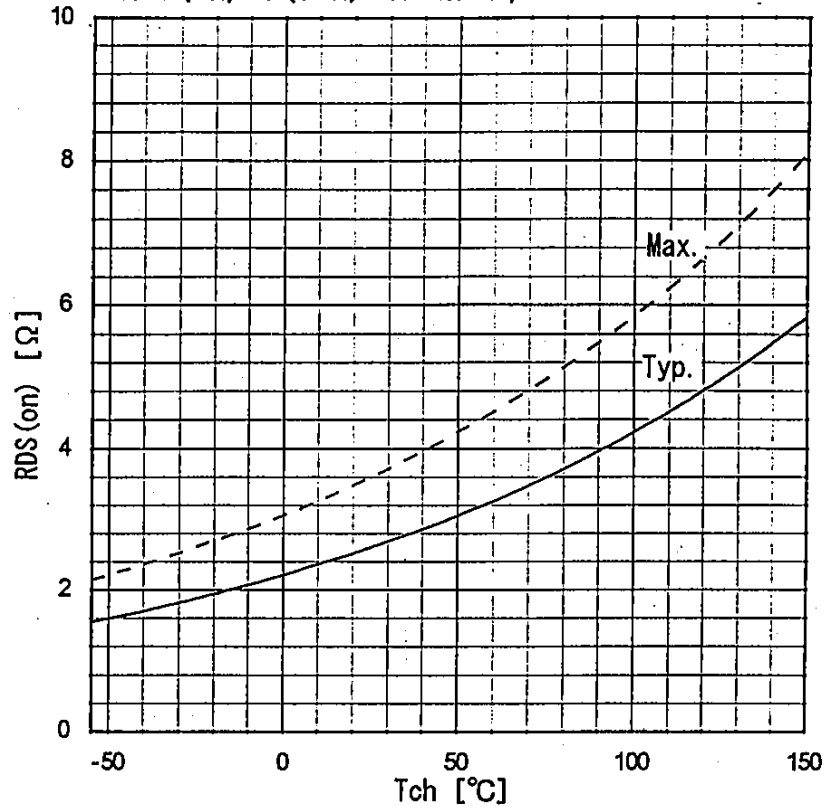
Typical transconductance
 $g_{fs} = f(I_D)$: $80 \mu s$ pulse test, $V_{DS} = 25V$, $T_{ch} = 25^\circ C$



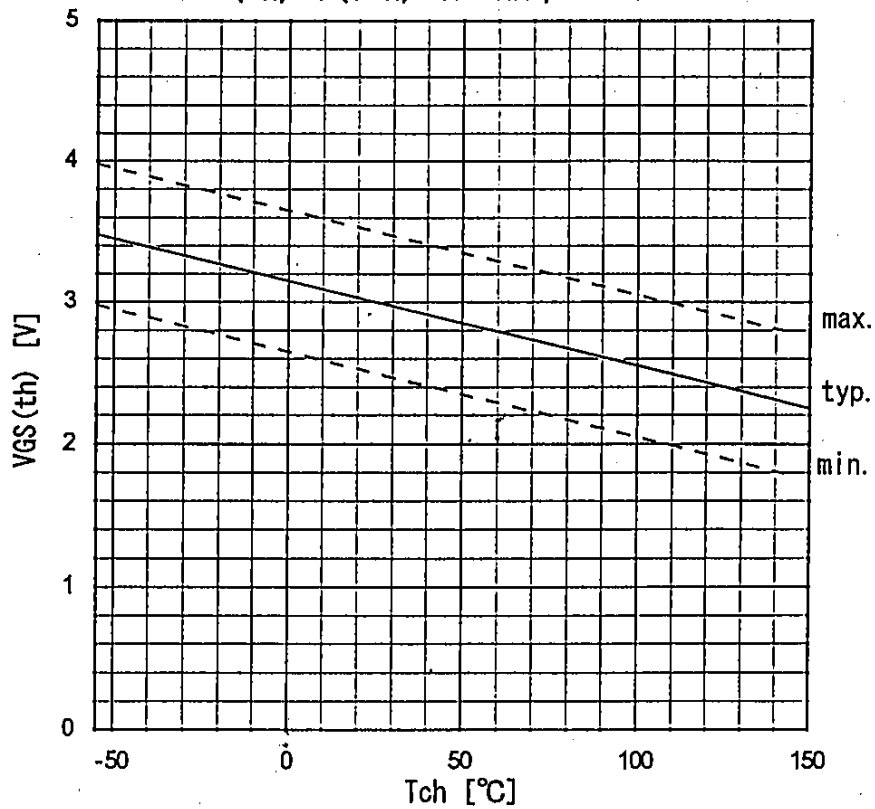
Typical drain-source on-state resistance
 $R_{DS(on)} = f(I_D)$: $T_{ch} = 25^\circ C$



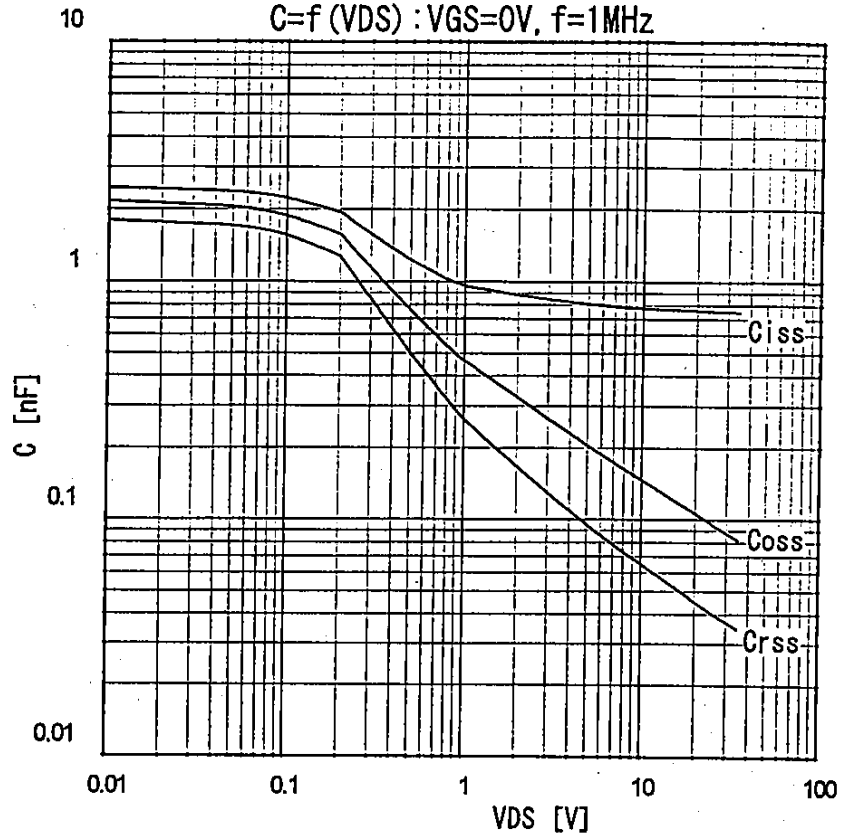
Drain-source on-state resistance
 $R_{DS(on)} = f(T_{ch}) : I_D = 2.5A, V_{GS} = 10V$



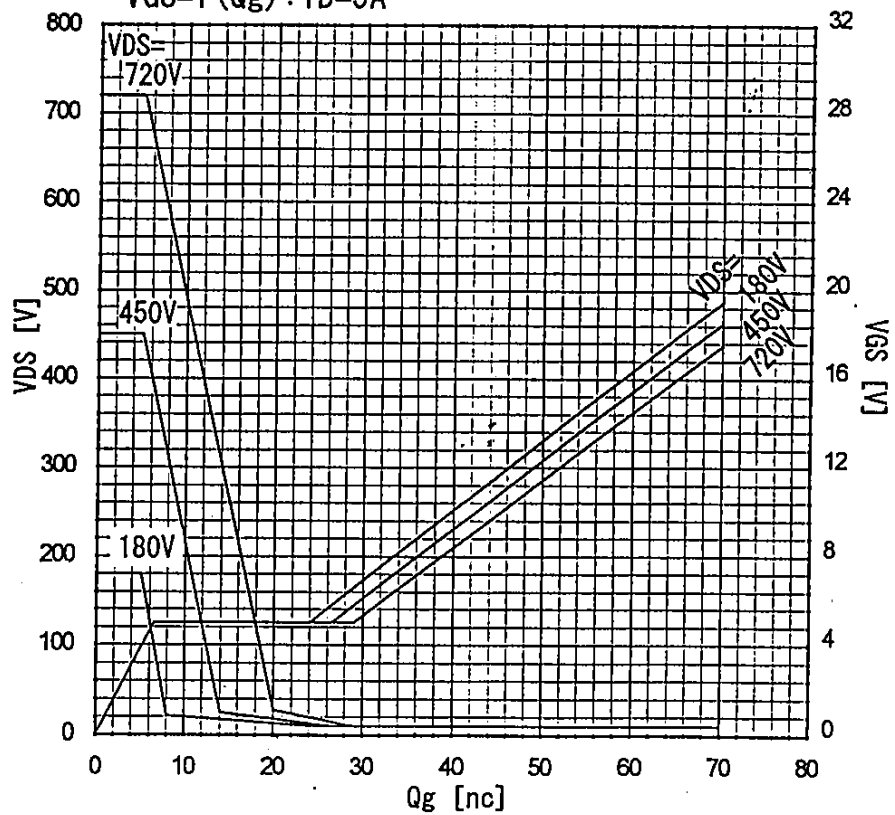
Gate threshold voltage
 $V_{GS(th)} = f(T_{ch}) : I_D = 1mA, V_{DS} = V_{GS}$



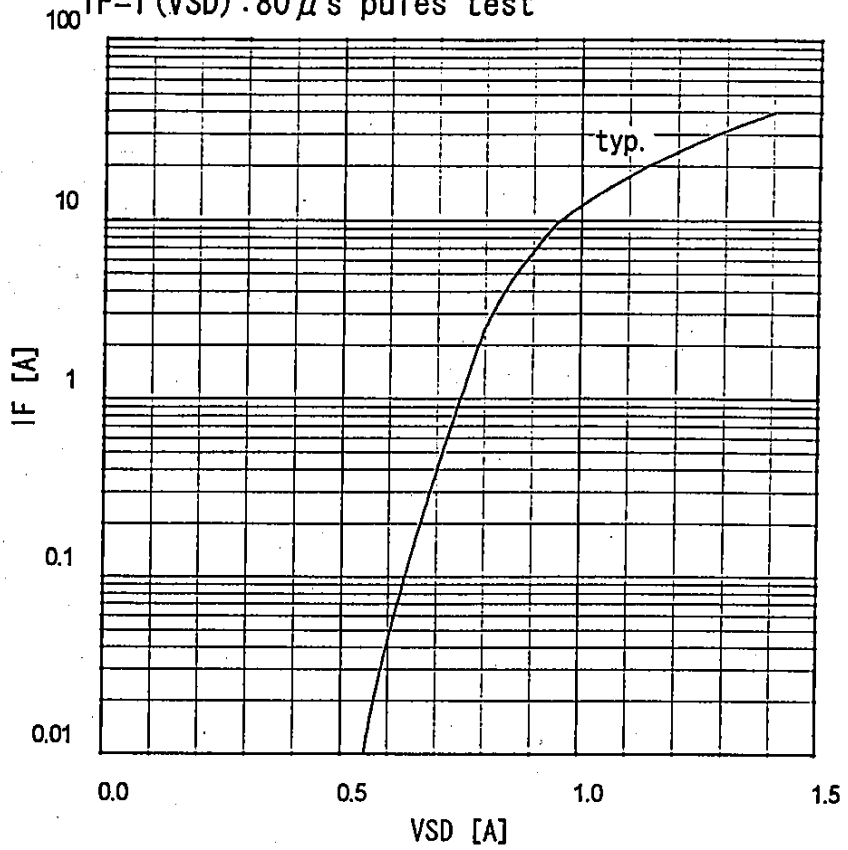
Typical capacitances
 $C=f(V_{DS}) : V_{GS}=0V, f=1MHz$



Typical gate charge characteristics
 $V_{GS}=f(Q_g) : I_D=5A$



Forward characteristic of reverse diode
 $I_F = f(V_{SD}) : 80 \mu s$ pulses test



Transient thermal impedance
 $Z_{th}(ch-c) = f(t)$ parameter: $D = t/T$

